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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR			
09/848,997	05/04/2001		ATTORNEY DOCKET NO.	CONFIRMATION NO.	
.,	03/04/2001	Lup San Leong	1016-013	8978	
	7590 12/17/2002			, •	
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IIIU SUNNYVALE-SARATOGA ROAD			EXAMINER		
SUITE AT		GUEDDEDO MARY			
SUNNYVALE	E, CA 94087		GUERRERO, MARIA F		
			ART UNIT	PAPER NUMBER	
			2822		
		DATE MAILED: 12/17/2002			

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.		Applicant(s)	1	
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3)	Since this application is in condition closed in accordance with the prac	tice under Ex parte Quaylo	e, 1935 C.D. 11,	100 4		
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4)[Claim(s) <u>1-20</u> is/are pending in the 4a) Of the above claim(s) <u>15-20</u> is/a	are withdrawn from conside	eration.			
. —	Claim(s) is/are allowed.					
5)LJ	Claim(s) local of the claim (s)					
	Claim(s) 1-14 is/are rejected.	•				
7)[Claim(s) is/are objected to.	riction and/or election requ	irement.			
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11)[The proposed drawing correction of the proposed, corrected drawings are	e required in reply to this Office	ce action.			
	If approved, corrected drawings and the control of	d to by the Examiner.				
12)[The oath or declaration is objects	•				
Priori	ty under 35 U.S.C. §§ 119 and 120 Acknowledgment is made of a cl	oim for foreign priority und	ler 35 U.S.C. § 1	19(a)-(d) or (f).		
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1	chment(s)		4) Interview	Summary (PTO-413 Informal Patent App	s) Paper No(s) · dication (PTO-152)	
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2)	Notice of Draftsperson's Patent Drawing Re Information Disclosure Statement(s) (PTO-	1449) Paper No(s) ·			Part of Paper No. 6	
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DETAILED ACTION

This Office Action is in response to the Amendment filed October 3, 2002.
 Claims 1-20 are pending.

Election/Restrictions

2. Applicant's election of Group I claims 1-14 in Paper No. 3 is acknowledged.

Because applicant did not distinctly and specifically point out the supposed errors in the restriction requirement, the election has been treated as an election without traverse (MPEP § 818.03(a)).

Claims 15-20 are withdrawn from further consideration pursuant to 37 CFR 1.142(b), as being drawn to a nonelected invention, there being no allowable generic or linking claim. Applicant timely traversed the restriction (election) requirement in Paper No. 3.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent are granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section applicant for patent, except that an international application of an application filed in the United States 351(a) shall have the effects for purposes of this subsection of an application filed in the United States and was published under Article 21(2) only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.
- 3. Claims 1-6 are rejected under 35 U.S.C. 102(e) as being anticipated by Levert et al. (U.S. 6,407,006).

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Levert et al. teaches placing a semiconductor wafer having an interlevel dielectric layer (ILD) on a wafer holder of an oven, applying mechanical pressure to the ILD layer using a mechanical device, applying heat simultaneously with the mechanical pressure (col. 7, lines 60-68, col. 26, lines 24-26). Levert et al. shows applying the mechanical pressure includes relative motion to assist in planarization, providing a non-sticking motion, sensing and controlling the temperature of the mechanical device (Abstract, col. 8, lines 5-15). Levert et al. shows the mechanical device using a roller (col. 7, lines 20-27).

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 7-14 are rejected under 35 U.S.C. 103(a) as being unpatentable over 4. Levert et al. (U.S. 6,407,006) in view of Oaks et al. (U.S. 6,083,661).

Levert et al. teaches placing a semiconductor wafer having an interlevel dielectric layer (ILD) on a wafer holder of an oven, applying mechanical pressure to the ILD layer using a mechanical device, applying heat simultaneously with the mechanical pressure (col. 7, lines 60-68, col. 26, lines 24-26). Levert et al. shows applying the mechanical pressure includes relative motion to assist in planarization, providing a non-sticking motion, sensing and controlling the temperature of the mechanical device (Abstract, col. 8, lines 5-15). In addition, Levert et al. teaches spinning a low dielectric constant ILD

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material and curing the low dielectric constant ILD material (col. 3, lines 10-15, 53-60, col. 7, lines 45-65, col. 17, lines 17-55). Levert et al. shows the mechanical device using a roller (col. 7, lines 20-27). Furthermore, Levert et al. teaches an annealing process (col. 24, lines 53-60).

Levert et al. does not specifically describe soft baking the low dielectric constant ILD material at a soft bake temperature, holding the low dielectric constant ILD material at a temperature below the hard bake temperature (between 100°C and 400°C). However, Oaks et al. describes soft baking the low dielectric constant ILD material at a soft bake temperature, holding the low dielectric constant ILD material at a temperature below the hard bake temperature (between 100°C and 400°C), and hard baking the low dielectric constant ILD material (col. 16, lines 60-65, col. 17, lines 10-15, col. 19, lines 65-67).

Therefore, it would have been obvious to a person of ordinary skill in the art at the time of the invention to modify Levert et al.'s process by specify the use of a conventional soft bake as taught Oaks et al. in order to remove the solvent not removed during the spin-coating process (Oaks et al., col. 19, lines 65-67).

Response to Arguments

Applicant's arguments filed October 3, 2002 have been fully considered but they are not persuasive. Claims 1-14 stand rejected.

Applicant argued that Levert et al. fails to show how the heat is applied. However, Levert et al. teaches placing a semiconductor wafer having an interlevel dielectric layer (ILD) on a wafer holder of an oven, applying mechanical pressure to the

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ILD layer using a mechanical device applying mechanical pressure to the ILD layer using a mechanical device, applying heat simultaneously with the mechanical pressure (col. 7, lines 60-68, col. 26, lines 24-26).

In addition, the elements must be arranged as required by the claim, but this is not an ipsissimis verbis test, i.e., identity of terminology is not required. In re Bond, 910 F.2d 831, 15 USPQ2d 1566 (Fed. Cir. 1990).

Conclusion

6. **THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Maria Guerrero whose telephone number is 703-305-0162.

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Art Unit: 2822 If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor Amir Zarabian can be reached on 703-308-4905. The fax phone numbers for the organization where this application or proceeding is assigned are 703-308-7722 for regular communications and 703-308-7724 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

December 16, 2002

AMIR ZARABIAN SUPERVISORY PATENT EXAMINER TECHNOLOGY CENTER 2800